4GBJ10005 THRU 4GBJ1010

Glass Passivated Bridge Rectifiers

Features

- Glass passivated chip
- Low forward voltage drop
- Ideal for printed circuit board
- High surge current capability
- •Meet UL flammability classification 94V-0

Mechanical Data

Polarity: Symbol marked on body

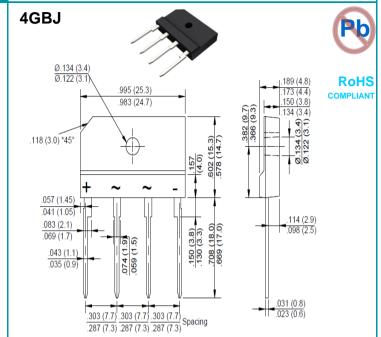
Mounting position: Any

Note: Products with logo or or are made by HY Electronic (Cayman) Limited.

Applications

 General purpose use in AC/DC bridge full wave rectification, for SMPS, lighting ballaster, adapter, etc.

Reverse Voltage - 50 to 1000 Volts Forward Current - 10.0 Amperes



Package Outline Dimensions in Inches (Millimeters)

Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristics	Symbol	4GBJ	4GBJ	4GBJ	4GBJ	4GBJ	4GBJ	4GBJ	Unit
	Symbol	10005	1001	1002	1004	1006	1008	1010	
Maximum Repetitive Peak Reverse Voltage	Vrrm	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	VDC	50	100	200	400	600	800	1000	V
Maximum Average Forward (with heatsink Note 2)	Lavo	10.0							А
Rectified Current @ Tc=100°C (without heatsink)	I(AV)	3.0							
Peak Forward Surge Current, 8.3mS Single Half Sine-Wave,	IFSM	210							Α
Superimposed on Rated Load (JEDEC Method)	IFSIVI	IF5W 210							A
I ² t Rating for Fusing (t<8.3mS)	l ² t	183						A ² s	
Peak Forward Voltage per Diode at 5A DC	VF	1.0							V
Maximum DC Reverse Current at Rated @TJ=25℃	lr	5.0							μА
DC Blocking Voltage per Diode @TJ=125°C	IK	500							
Typical Junction Capacitance per Diode (Note1)	C1	55						pF	
Typical Thermal Resistance to Ambient (without heatsink)	RөJA	24							°C/W
Typical Thermal Resistance to case (with heatsink (Note2))	Rejc	1.4							°C/W
Typical Thermal Resistance to lead (without heatsink)	Røjl	3						°C/W	
Operating Junction Temperature Range	TJ	-55 to +150							$^{\circ}$
Storage Temperature Range	Тѕтс	-55 to +150							$^{\circ}$

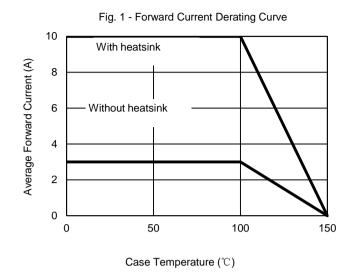
Notes: 1. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.

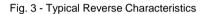
2.Device mounted on 150mm*150mm*1.6mm Cu plate heatsink.

3. The typical data above is for reference only

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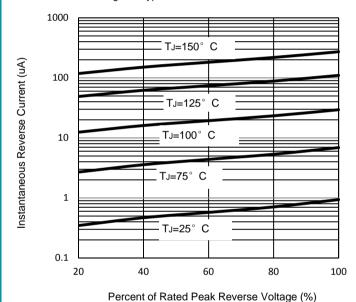


Fig. 2 - Maximum Non-Repetitive Surge Current

250

8.3mS Single Half-Sine-Wave
(JEDEC METOD)

150

100

1 10 100

Number of Cycles at 60Hz

Fig. 4 - Typical Forward Characteristics

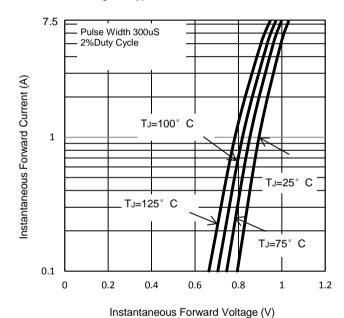
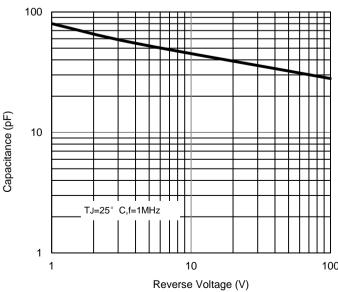


Fig. 5 - Typical Junction Capacitance



The curve above is for reference only.

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ALL specifications and data are subject to be changed without notice to improve reliability function or design or other reasons.

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